

**SPECIFICATION FOR APPROVAL****1/6W, 0402, Low Resistance Chip Resistor (Lead / Halogen Free)****1. Scope**

This specification applies to 1.0mm x 0.5mm size 1/6W, fixed thick film low resistance value chip resistors rectangular type.

2. Type DesignationRLT0510 - 7 -

(1) (2) (3) (4)

Where (1) Size No.

(2) Power Rating:

7 = 1/6W

(3) Resistance value:

For example --

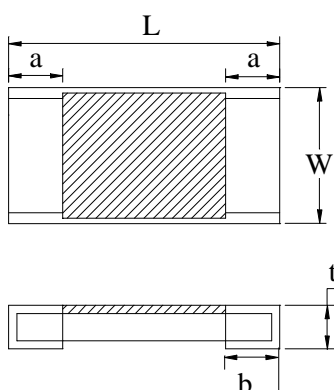
R075 = 0.075Ω

R100 = 0.100Ω

The "R" shall be used as a decimal point

(4) Resistance tolerance:

F = ±1.0%, G = ±2%, J = ±5%

3. Outline Dimensions

Code Letter	Dimension
L	1.00 ± 0.10
W	0.50 ± 0.10
t	0.35 +0.15/-0.10
a	0.25 ± 0.10
b	0.30 ± 0.10

Unit : mm



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4. Ratings

4-1 Specification

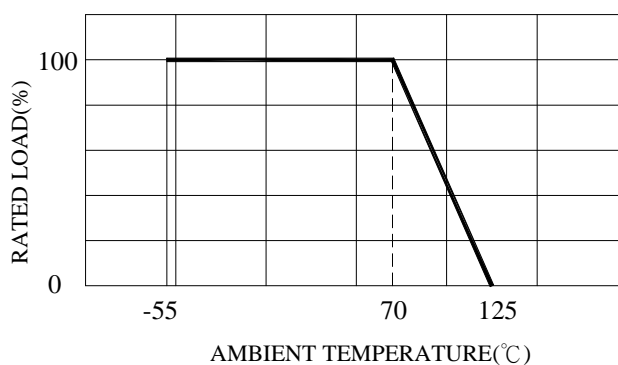
Table 1

Power Rating*	1/6W	
Resistance Tolerance	1%(F), 2%(G), 5%(J)	
Resistance Range	0.065 ~ <0.60 Ω	0.60 ~ 1.0 Ω
Temperature Coefficient of Resistance(ppm/ $^{\circ}\text{C}$)	± 300	± 200
Operating Temperature Range	-55 $^{\circ}\text{C}$ to 125 $^{\circ}\text{C}$	

Note*:

Power Rating is based on continuous full load operation at rated ambient temperature of 70 $^{\circ}\text{C}$.

For resistor operated at ambient temperature in excess of 70 $^{\circ}\text{C}$, the maximum load shall be derated in accordance with the following curve.



4-2 Rated Voltage

The d.c. or a.c. r.m.s. voltage shall be calculated from the following expression

$$V = \sqrt{P \times R}$$

Where V : Rated voltage (V)

P : Rated power (W)

R : Nominal resistance (Ω)

4-3 Operating and Storage Temperature Range

-55 to +125 $^{\circ}\text{C}$



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5. Characteristics

5-1 Electrical

Item	Specification and Requirement	Test Method (JIS 5201)
Temperature Coefficient of Resistance (TCR)	As follow table 1.	Room temperature Room temperature+100°C
Short Time Overload	$\Delta R: \pm 1.0\%$ Without damage by flashover, spark, arcing, burning or breakdown	(1) Applied voltage: 2.5 x rated voltage (2) Test time: 5 seconds
Insulation Resistance	Over 100 M Ω on Overcoat layer face up Over 1,000 M Ω on Substrate side face up	(1) Setup as figure 1 (2) Test voltage: 100V _{DC} \pm 15V _{DC} (3) Test time: 60 + 10 / - 0 seconds
Voltage Proof	Resistance range: $\pm 1.0\%$ Without damage by flashover, spark, arcing, burning or breakdown	(1) Setup as figure 1 (2) Test voltage: 100V _{AC} (rms.) (3) Test time: 60 + 10 / - 0 seconds

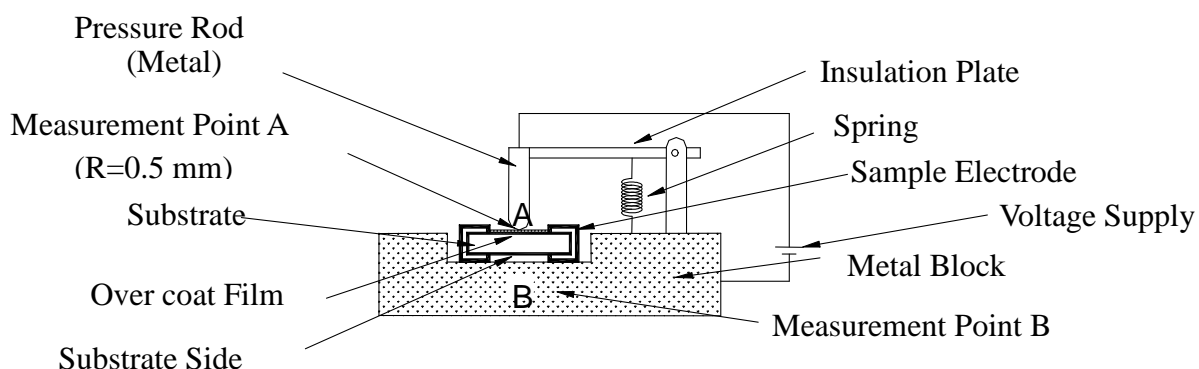


Figure 1 : Measurment Setup

**SPECIFICATION FOR APPROVAL****5-2 Mechanical**

Item	Specification and Requirement	Test Method (JIS 5201)
Solderability	The surface of terminal immersed shall be minimum of 95% covered with a new coating of solder	Solder bath: After immersing in flux, dip in $245 \pm 5^{\circ}\text{C}$ molten solder bath for 2 ± 0.5 seconds
Resistance to Solder Heat	$\Delta R: \pm 1.0\%$ Without distinct deformation in appearance	(1) Pre-heat: $100\sim 110^{\circ}\text{C}$ for 30 seconds (2) Immersed at solder bath of $270 \pm 5^{\circ}\text{C}$ for 10 ± 1 seconds (3) Measuring resistance 1 hour after test
Bending Test	$\Delta R: \pm 1.0\%$ Without mechanical damage such as break	Bending value: 3 mm for 30 ± 1 seconds

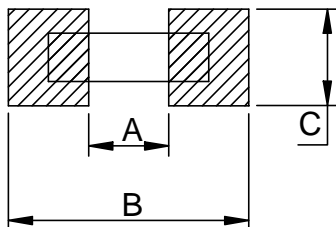
**SPECIFICATION FOR APPROVAL****5-3 Endurance**

Item	Specification and Requirement	Test Method (JIS 5201)
Rapid Change of Temperature	$\Delta R: \pm 1.0\%$ Without distinct damage in appearance	(1) Repeat 5 cycle as follow: (-55 \pm 3 $^{\circ}$ C ,30minutes) →(Room temperature, 2~3 minutes) →(+125 \pm 2 $^{\circ}$ C ,30minutes) →(Room temperature 2~3 minutes) (2) Measuring resistance 1 hour after test
Moisture with Load	$\Delta R: \pm 5.0\%$ Without distinct damage in appearance	(1) Environment condition: 40 \pm 2 $^{\circ}$ C ,90~95% RH (2) Applied Voltage: rated voltage (3) Test period: (1.5 hour ON) →(0.5 hour OFF) cycled for total 1,000 + 48 / - 0 hours (4) Measuring resistance 1 hour after test
Load Life	$\Delta R: \pm 5.0\%$ Without distinct damage in appearance	(1) Test temperature: 70 \pm 3 $^{\circ}$ C (2) Applied Voltage: rated voltage (3) Test period: (1.5 hour ON) →(0.5 hour OFF) cycled for total 1,000 + 48 / - 0 hours (4) Measuring resistance 1 hour after test
Low Temperature Store	$\Delta R: \pm 5.0\%$ Without distinct damage in appearance	(1) Store temperature: -55 \pm 3 $^{\circ}$ C for total 1,000 + 48 / - 0 hours (2) Measuring resistance 1 hour after test
High Temperature Store	$\Delta R: \pm 5.0\%$ Without distinct damage in appearance	(1) Store temperature: +125 \pm 2 $^{\circ}$ C for total 1,000 + 48 / - 0 hours (2) Measuring resistance 1 hour after test



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6. Recommend Land Pattern Dimensions



A	0.6~1.0
B	2.0~2.4
C	0.6~1.0

Unit : mm

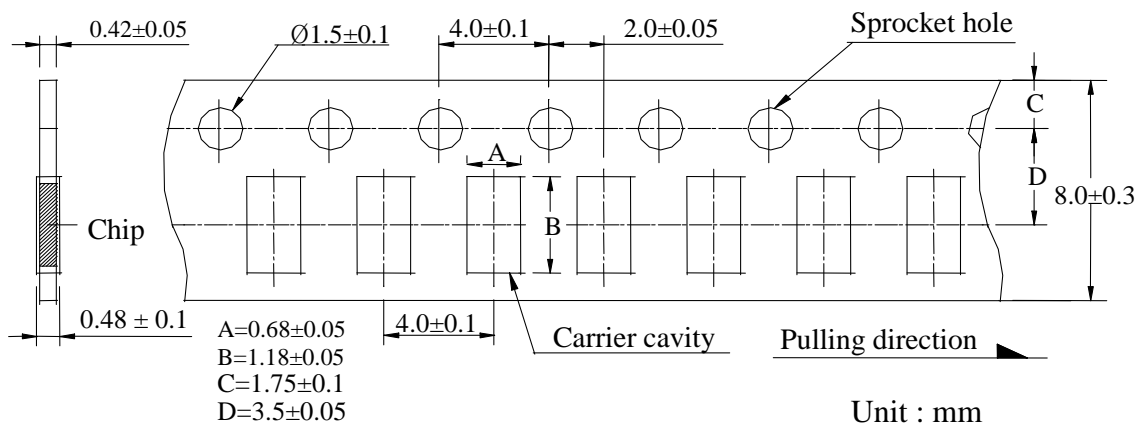


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7. Packaging

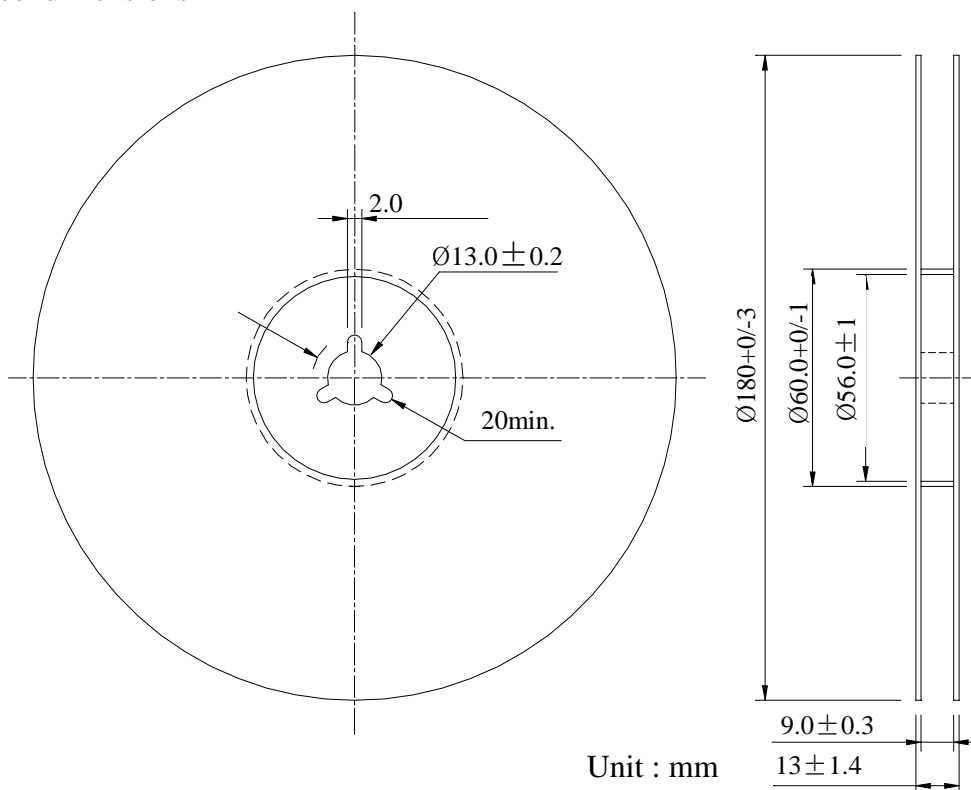
7-1 Dimensions

7-1-1 Tape packaging dimensions



Remark: Leader tape length ≥ 30 cm(150 Hollow carrier cavity)

7-1-2 Reel dimensions





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DOCUMENT : SRK270000NH

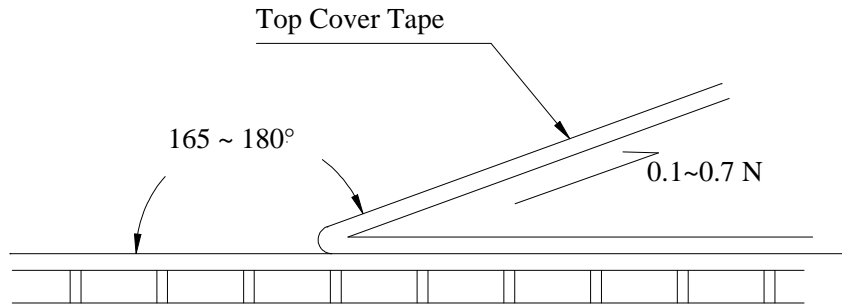
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7-2 Peel force of top cover tape

The peel speed shall be about 300 mm/min.

The peel force of top cover tape shall be between 0.1 to 0.7 N.



7-3 Numbers of taping 10,000 pieces /reel

7-4 Label making

The following items shall be marked on the reel.

- (1) Type designation.
- (2) Quantity
- (3) Manufacturing date code
- (4) Manufacturer's name



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8. Carenote

8-1 Care note for storage

- (1) Chip resistor shall be stored in a room where temperature and humidity must be controlled. (temperature 5 to 35°C , humidity 45 to 85% RH) However, a humidity keep it low, as it is possible.
- (2) Chip resistor shall be stored as direct sunshine doesn't hit on it.
- (3) Chip resistor shall be stored with no moisture, dust, a material that will make solderability inferior, and a harmful gas (Chloridation hydrogen, sulfurous acid gas, and sulfuration hydrogen)

8-2 Carenote for operating and handling

- (1) It is necessary to protect the edge and protection coat of resistors from mechanical stress.
- (2) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
- (3) Resistors shall be used with in rated range shown in specification. Especially, if voltage more than specified value will be loaded to resistor, there is a case it will make damage for machine because of temperature rise depending on generating of heat, and increase resistance value or breaks.
- (4) In case that resistor is loaded a rated voltage, it is necessary to confirms temperature of a resistor and to reduce a load power according to load reduction curve, because a temperature rise of a resistor depends on influence of heat from mounting density and neighboring element.
- (5) Observe Limiting element voltage and maximum overload voltage specified in each specification
- (6) If there is possibility that a large voltage (pulse voltage, shock voltage) charge to resistor, it is necessary that operating condition shall be set up before use.